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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT:

Y. BYUN et al.

TITLE:

AMPHIPHILIC

POLYSACCHARIDE

**DERIVATIVES** 

SERIAL NO.:

09/300,173

SUPPLEMENTAL

DECLARATION BY THE

FILED: April 27, 1999

INVENTORS UNDER 37 C.F.R. § 1.67

**EXAMINER:** 

K. Fonda

ART UNIT:

1623

)

Commissioner for Patents Washington, D.C. 20231

## Sir:

We, Youngro BYUN and Yong-Kyu LEE declare: that we are citizens of Korea; and we the two inventors named in the above-identified patent application, hereby declare: that our addresses are #103-1305 KumKwang Apt., Wallgye-dong, Kwangsan-ku, Kwangju, 506-302, Korea, and Dormitory 4301, Kwangju Institute of Science and Technology, 1 Oryong-dong, Puk-gu, Kwangju, 500-712, Korea,

Certificate of Deposit Under 37 C.F.R. § 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to Commissioner for Patents, Washington, D.C. 20231, on the April \_\_\_\_\_\_\_, 2001.

Alan J. Howarth Attorney Registration No. 36,553 Attorney for Applicant

respectively; that we verily believe we are the original, first, and joint inventors of the subject matter of the invention for which a patent is sought and which is described and claimed in the above-identified application; that we have reviewed and understand the contents of the specification of the above-identified application, including the claims; that we have reviewed and understand the contents of an amendment mailed November 15, 2000, and another amendment mailed February 12, 2001, including the claims amended therein and we do hereby declare that the claims as amended accurately define at least a portion of the invention; and that we acknowledge the duty to disclose information which is material to the examination of this application in accordance with Section 1.56(a) of Title 37 of the Code of Federal Regulations. claim the benefit under Section 120 of Title 35 of the United States Code of the earlier filed pending Korean application, Serial No. 19469, filed May 28, 1998; and, insofar as the subject matter of each of the claims of this application is not disclosed in the earlier filed pending application in the manner provided by the first paragraph of Section 112 of Title 35 of the United States Code, we acknowledge the duty to disclose material information, as defined in Section 1.56 of Title 37 of the Code of Federal Regulations, which occurred between the filing date of the earlier filed application and the filing date of this application.

We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful, false statements may jeopardize the validity of the application or any patent issuing thereon.

Signed at Kwangju, Republic of Kovag this (State)

28th day of Feburary, 2001

Inventor Journey Byun

#103-1305 KumKwang Apt. Wallgye-dong, Kwangsan-ku Kwangju, 506-302 Korea

Signed at Kwangju , Republic of Korea, this (City)

28th day of Fieburary, 2001.

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